LOW-VOLTAGE DIFFERENTIAL SCSI (LVD) 27-LINE REGULATOR SET

FEATURES

- **SCSI SPI-2, SPI-3 and SPI-4 LVD SCSI 27-Line, Low-Voltage Differential Regulator**
- **2.7-V to 5.25-V Operation**
- **Integrated Regulator Set for LVD SCSI**
- **Differential Failsafe Bias**

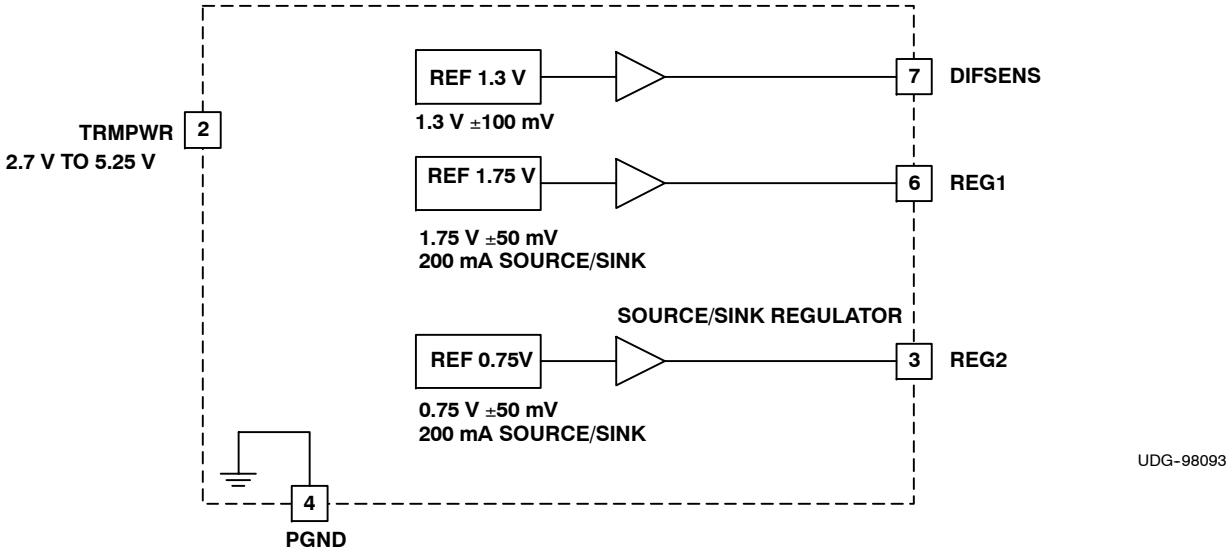
APPLICATIONS

- **Servers**
- **Workstations**
- **RAID Boxes**

DESCRIPTION

The UCC561 low-voltage differential (LVD) regulator set is designed to provide the correct references voltages and bias currents for LVD termination resistor networks (475 Ω, 121 Ω, and 475 Ω). The device also provides a 1.3-V output for “diff sense” signaling. With the proper resistor network, the UCC561 solution meets the common mode bias impedance, differential bias, and termination impedance requirements of SPI-2 (Ultra2), SPI-3 (Ultra3/Ultra160) and SPI-4 (Ultra320). The UCC561 is not intended for SPI-5 applications.

This device incorporates into a single monolith, two sink/source reference voltage regulators, a 1.3-V buffered output and protection features. The protection features include thermal shutdown and active current-limiting circuitry. The UCC561 is offered in 16-pin SOIC (DP) package.



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION

PRODUCT	PACKAGE-LEAD	PACKAGE DESIGNATOR	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	TRANSPORT MEDIA, QUANTITY
UCC561	SOIC-16	DP	0°C to 70°C	UCC561DP	Rail, 70

(1) For the most current specification and package information, refer to our web site at www.ti.com.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted(1)(2)

	UCC561	UNIT
TERMPWR	6	V
Package dissipation	1.2	W
Junction temperature, T_J	-55 to 150	°C
Storage temperature, T_{stg}	-65 to 150	°C

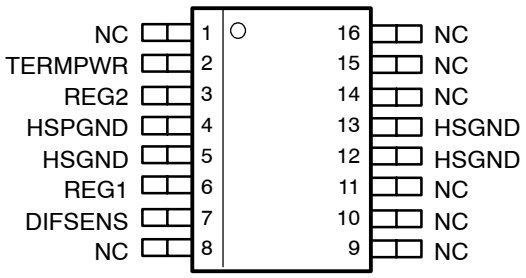
(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) Currents are positive into and negative out of the specified terminals.

RECOMMENDED OPERATING CONDITIONS

	MIN	NOM	MAX	UNIT
$V_{TERMPWR}$, TermPower voltage	2.70		5.25	V

DP PACKAGE
(TOP VIEW)



NC = No connection

ELECTRICAL CHARACTERISTICS

T_J = 0°C to 70°C, $V_{TERMPWR}$ = 3.3 V unless otherwise noted(1)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
TERMPWR Supply Current					
TERMPWR supply current	No load			40	mA
TERMPWR voltage		2.70		5.25	V
Regulator					
1.75-V regulator	REG1 (±125 mA)	1.70	1.75	1.80	V
1.3-V regulator	−5 mA ≤ $I_{DIFSENS}$ ≤ 50 μA	1.2	1.3	1.4	V
0.75-V regulator	REG2 (±125 mA)	0.70	0.75	0.80	V
1.75-V regulator source current	V_O = 1.25 V	−200			mA
1.75-V regulator sink current	V_O = 2.25 V	200			mA
1.75-V regulator source current limit(1)		−200		−700	mA
1.75-V regulator sink current limit(1)		200		700	mA
1.3-V regulator source current	$V_{DIFSENS}$ = 0 V	−5		−15	mA
1.3-V regulator sink current	$V_{DIFSENS}$ = 2.4 V	50		200	μA
0.75-V regulator source current	V_O = 0.25 V	−200			mA
0.75-V regulator sink current	V_O = 1.25 V	200			mA
0.75-V regulator source current limit(1)		−200		−700	mA
0.75-V regulator sink current limit(1)		200		700	mA

(1) Ensured by design. Not production tested.

TERMINAL FUNCTIONS

TERMINAL		I/O	DESCRIPTION
NAME	NO.		
HSPGND	4	–	Heat sink power ground pin.
HSGND	5, 12, 13	–	Heat sink ground pin which should be attached to the ground plane on a multilayer board or large copper area on a 2 layer board.
REG1	6	O	1.75-V source/sink regulated output voltage pin. The part is internally current limited for both sinking and sourcing current to prevent damage. For best performance, a 4.7-μF low-ESR capacitor is recommended. Lead lengths should be kept to a minimum.
REG2	3	O	0.75-V source/sink regulated output voltage pin. The part is internally current limited for both sinking and sourcing current to prevent damage. For best performance, a 4.7-μF low-ESR capacitor is recommended. Lead lengths should be kept to a minimum.
DIFSENS	7	O	1.3-V source/sink regulated output voltage pin. The part is internally current limited to the SCSI SPI-2 through SPI-4 standards for both sinking and sourcing current to prevent damage.
TERMPWR	2	I	Supply voltage pin. The pin should be decoupled with at least a 2.2-μF low-ESR capacitor. For best performance, a 4.7-μF low-ESR capacitor is recommended. Lead lengths should be kept to a minimum.

APPLICATION INFORMATION

The resistor stack with the 1.75-V and 0.75-V reference gives the correct differential impedance, bias voltage, common mode differential impedance, and common mode voltage as show in Table 1.

Table 1. UCC561 Resistor Stack vs. Standard (SPI–2 through SPI–4)

PARAMETER	UCC561	STANDARD	UNITS
Differential Impedance	107.3	100 to 110	Ω
Differential bias voltage	112.9	100 to 125	mV
Common-mode differential impedance	237	100 to 300	Ω
Common-mode voltage	1.25	1.2 to 1.3	V

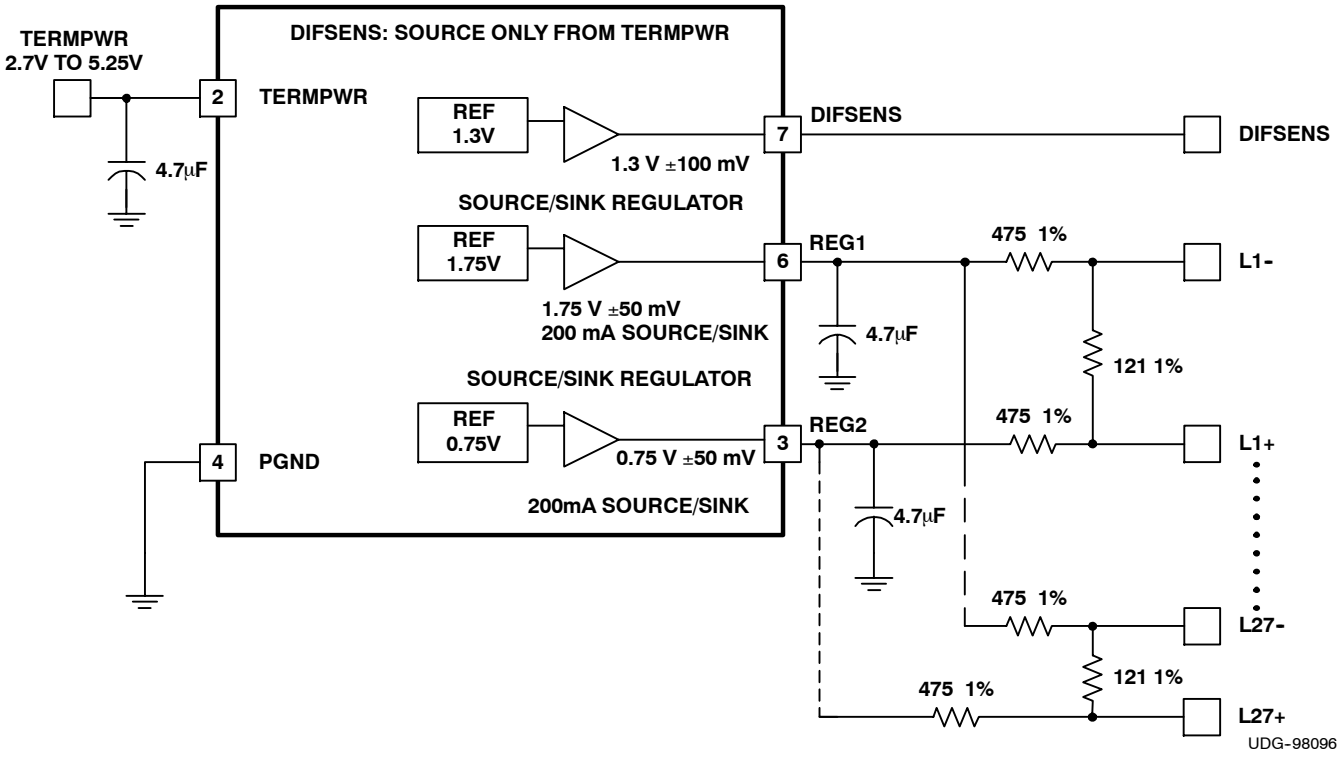


Figure 1. Low-Voltage Differential Discrete Resistor Stack

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